

POWER METAL FILM CHIP RESISTORS

How to Order:

Series: SMF Part No.

<u>SMF</u>	<u>300</u>	<u>J</u>	<u>200R</u>
Series Power Metal Film Chip Resistor	Wattage SMF200=2W SMF300=3W SMF500=5W	Tolerance F=1% J=5%	Value 10R=10 ohm 1K=1000 ohm 2.3K=2K3 2M=2M

Note:

SMF200=2W, SMF300=3W, SMF500=5W

The normal packing of POWER METAL FILM CHIP RESISTOR is Tape / Reel.

The normal tolerance of POWER METAL FILM CHIP RESISTOR is 5%.

The standard value for 5% is 10 ohm to 2 Meg.

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SMF Series

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■ INTRODUCTION

This standard specification is for use in consumer electronics, computers, telecommunications, control instruments...etc.

Remark :SMF Series Resistors are RoHS Compliant.

■ STRUCTURE

1 Material:

Terminal is to be firmly connected with resistors element, both electrically and mechanically, and allow easy soldering.

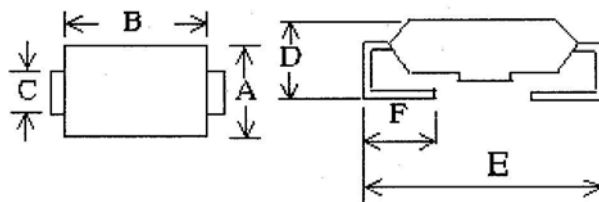
2 Coating:

Flameproof UL94V0 molded package, resistant to heat, humidity & insulation.

3 Marking:

Marking is made on the surface with Rated Wattage, Nominal Resistance and Tolerance.

DIMENSIONS:



STYLE	DIMENSION (mm)						Max Working Voltage	VALUE RANGE
	A±0.3	B±0.3	C±0.3	D±0.3	E max.	F±0.3		
SMF200	4.0	6.7	1.4	3.55	7.9	1.5	300V	10R-2M
SMF300	5.5	10.5	1.7	5.0	12	2.3	500V	10R-2M
SMF500	7.3	13.5	1.7	6.8	17	2.5	500V	10R-2M

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■ ELECTRICAL CHARACTERISTICS

Operating Temperature Range: $-55^{\circ}\text{C} \sim 200^{\circ}\text{C}$

Resistance Temperature Coefficient:

It shall be within : $\pm 100\text{ppm}/^{\circ}\text{C}$

$$\text{T.C (ppm}/^{\circ}\text{C}) = \left[\frac{R2 - R1}{R1} \right] \times \left[\frac{1}{T2 - T1} \right] \times 10^6$$

where

R1: resistance value at reference temperature

R2: resistance value at test temp.

T1: reference temp. (usu. 25°C)

T2: test temp. (about 75°C)

Temperature Cycle:

Following temp. cycles are to be made 5 times and then put at room temp. for one hour, the resistance value change rate between pre-and-post test shall be within $\pm 1\%$.

Steps	Temperature($^{\circ}\text{C}$)	Time (minutes)
1 st step	-55 ± 3	30
2 nd step	Room temp.	2~3
3 rd step	200 ± 3	30
4 th step	Room temp.	2~3

Short Time Over Load:

When the resistors are applied 5 times as much as rated wattage for 5 seconds continuously, it shows no evidence of arc, flame...etc. Removing the voltage and place the resistors to the normal condition for 30 minutes, the resistance value change rate between pre-and-post test shall be within $\pm 0.5\%$.

Insulation Character:

Resistors are located in a jig and applying DC 500V, measuring the Insulation Resistance which shall be over $10000\text{M}\Omega$.

Voltage Withstanding:

Resistors are located in a jig and applying AC 500V for 1 minute and should find no physical damage to the resistors, such as arc, char...etc.

Load Life:

The resistors arrayed are sent into the 70°C oven, applying rated voltage at the cycle of 1.5 hours ON, 0.5 hour OFF for 1000_{0}^{+48} hours in total. Then, after removing the voltage, take the resistors out of the oven and left under normal temp. for about one hour for cooling. The resistance value change rate between pre-and-post test shall be within $\pm 1\%$.

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Moisture-proof Load Life:

The resistors arrayed are placed into a constant temp./humidity oven at the temp. of $40 \pm 2^\circ\text{C}$ and the humidity of 90~95%, then rated power is applied for 1.5 hours and cut off for 0.5 hour. The similar cycle will be repeated for 500_{-0}^{+24} hours in total (including cut-off time). Then remove the voltage, taking the resistors out of the oven and leaving them at room temp. for one hour. The resistance value change rate between pre-and-post test shall be within $\pm 1\%$. There also shall be no evidence of remarkable change on appearance, and the marking shall not be illegible.

Solder-ability:

Immerse the resistors in the solder pot at $235 \pm 5^\circ\text{C}$ for 2 seconds. At least 95% solder coverage on the termination.

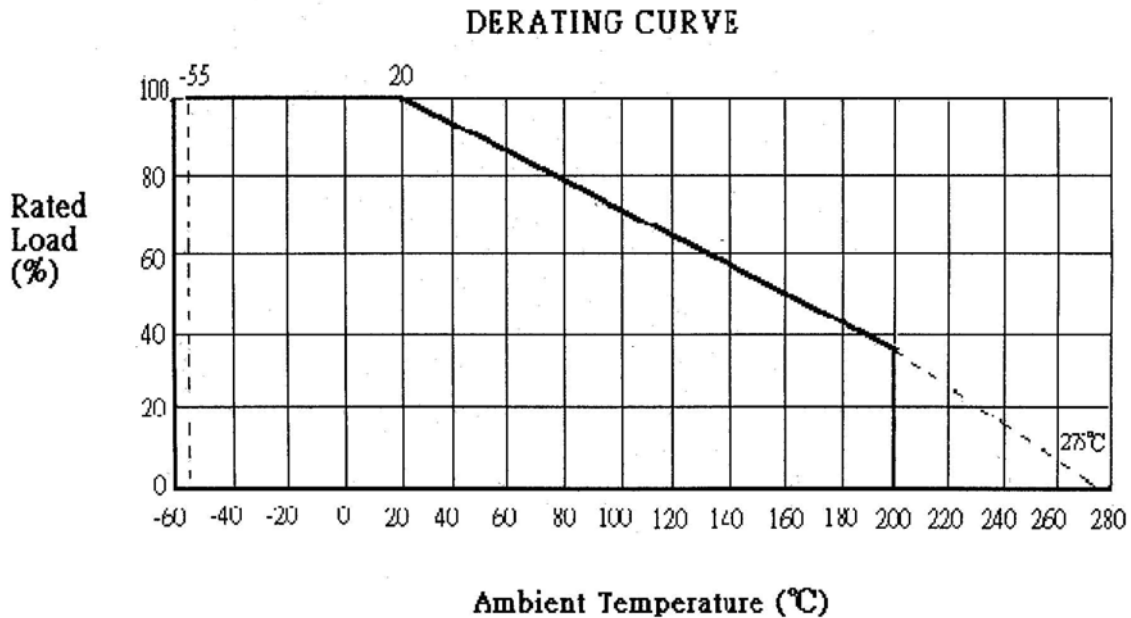
Resistance to Soldering Heat:

Immerse the resistors in the solder pot at $270 \pm 5^\circ\text{C}$ for 10 ± 1 seconds. Then remove the resistors out of the solder pot and leaving them at room temp. for one hour for cooling. The resistance value change rate between pre-and-post test shall be within $\pm 1\%$.

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■ Rated Power:

Rated power is the value of Max load voltage specified at the ambient temperature of 20°C, and shall meet the functions of electrical and mechanical performance. When the ambient temperature surpasses above mentioned temperature, the value declines as per following DERATING CURVE.



■ Rated Voltage:

It is calculated through the following formula:

$$E = \sqrt{PXR}$$

where E: rated voltage (V)
P: rated power (W)
R: total nominal resistance (Ω)